

# DMT057VGNTRS0-1A PRODUCT SPECIFICATION

Version 0.2 Aug 05, 2021

**TBD** 

Customer's Approval				
<u>Signature</u>	<u>Date</u>			

Prepared by *Chi Huang*Approved by *Evan Huang* 



## **Revision History**

VERSION	DATE	DESCRIPTION	AUTHOR
0.1	Jul 30, 2021	Preliminary	Chi Huang
0.2	Aug 05, 2021	Page.5 Modified the main features Page.7 Mechanical drawing updated. Page.9 Pin Assignment updated. Page.16 Viewing Angle updated.	Chi Huang

# **Legal Notice**

Copyright ©2021 Quixant UK Limited trading as Densitron

All information contained in this document is proprietary and confidential to Quixant UK Limited trading as Densitron and is subject to a non-disclosure agreement. Unauthorized use, duplication, modification or disclosure of this information by any means without prior consent of Quixant UK Limited trading as Densitron is prohibited.

Every effort has been made to ensure the accuracy of this document; however, Quixant UK Limited trading as Densitron accepts no responsibility for any inaccuracies, errors or omissions herein. Quixant UK Limited trading as Densitron reserves the right to change specifications without prior notice in its absolute discretion, to supply the best product possible. Where Quixant UK Limited trading as Densitron or any of its group companies has (i) made a change to a product to incorporate a specific customer requirement or (ii) has created a design to a customer's specific requirements, in either case the customer will indemnify and hold the relevant Densitron entity harmless against any claim that delivery against such requirement breaches any intellectual property or other rights of any 3rd party.

All brands and trademarks are the property of their respective owners and are hereby fully acknowledged.



# **Table of Contents**

1.	GENE	RAL DESCRIPTION	5
	1.1	Introduction	5
	1.2	Main Features	5
2.	MECH	HANICAL SPECIFICATION	6
	2.1	Mechanical Characteristics	
	2.2	Mechanical Drawing	7
3.	ELECT	RICAL SPECIFICATION	8
	3.1	Absolute Maximum Ratings	8
	3.2	Electrical Characteristics	8
	3.3	Interface Pin Assignment	9
	3.4	Block Diagram	10
	3.5	Timing Characteristics	
4.	ELECT	RICAL SPECIFICATION TOUCH	14
	4.1	Conditions of Use and Storage	14
	4.2	Electrical Property	14
	4.3	Mechanical Property	
5.	OPTIC	CAL SPECIFICATION	16
	5.1	Optical Characteristics	16
6.	LED B	ACKLIGHT SPECIFICATION	18
	6.1	LED Backlight Characteristics	18
	6.2	INTERNAL CIRCUIT DIAGRAM	18
7.	PACK	AGING	19
8.	QUAL	ITY ASSURANCE SPECIFICATION	20
	8.1	Conformity	20
	8.2	Environment Required	20
	8.3	Delivery Assurance	20
	8.4	Dealing with Customer Complaints	29
9.	RELIA	BILITY SPECIFICATION	30
	9.1	Reliability Tests	30





10.	HANDLII	NG PRECAUTIONS	3
	10.1	Handling Precautions	31
	10.2	Storage Precautions	32
	10.3	Designing Precautions	32
	10.4	Operation Precautions	33
	10.5	Other Precautions	33



# 1. General Description

## 1.1 Introduction

This is a 5.7" size colour active matrix TFT LCD module that uses amorphous silicon TFT as a switching device. The display is normally white mode, transmissive, and featuring high contrast and excellent colour saturation. The resolution of the TFT-LCD is 640 x 480 and can display up to 262Kcolours. The display module supports 18 BIT RGB interface and tape bonding 4 wire resistive touch panel.

#### 1.2 Main Features

Item	Contents		
Display Type	TFT LCD		
Screen Size	5.7" Diagonal		
Display Format	640 x RGB x 480 Dots		
No. of Colour	262K		
Overall Dimensions	127(W) x 98.43 (H) x 7.5 (D) mm		
Active Area	115.2 (W) x 86.4 (H) mm		
Mode	Normally White / TN / Transmissive		
Surface Treatment	Anti-glare (3H)		
Viewing Direction	6 o'clock		
Interface	18 BIT RGB		
Driver IC	HX8250-A *2 & HX8678-A		
Backlight Type	LED, White, 24 chips		
Touch Panel	Resistive Touch Panel		
Touch Interface	4 Wire		
Bonding Type	Tape Bonding		
Operating Temperature	-20°C ~ +70°C		
Storage Temperature	-30°C ~ +80°C		
ROHS	Compliant to RoHS 2.0		



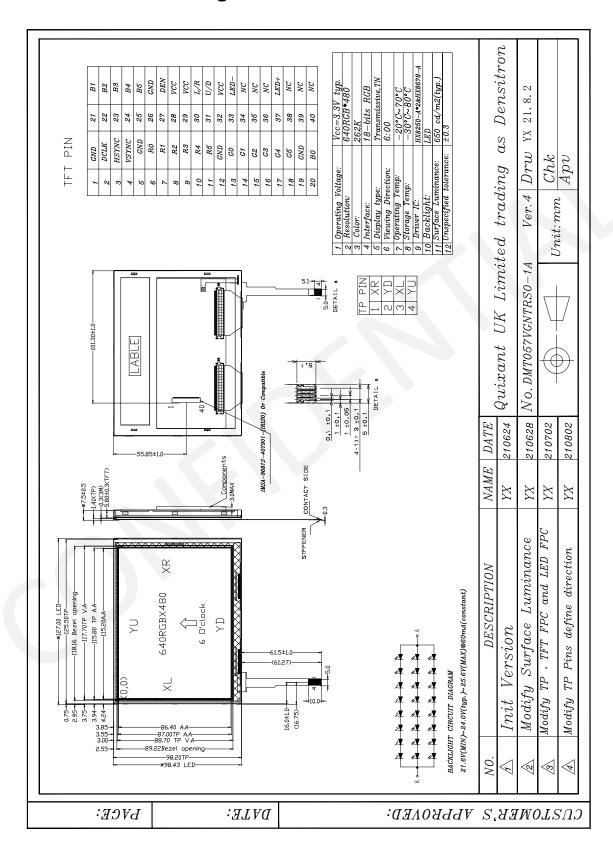
# 2. Mechanical Specification

## 2.1 Mechanical Characteristics

Item	Characteristic	Unit		
Display Format	640 x RGB x 480	Dots		
Overall Dimensions	127(W) x 98.43 (H) x 7.5 (D)	mm		
Active Area	115.2 (W) x 86.4 (H)	mm		
Dot Pitch	0.18 (W) x 0.18(H)	mm		
Weight	TBD	g		
IC Controller/Driver	HX8250-A *2 & HX8678-A			



#### 2.2 Mechanical Drawing





# 3. Electrical Specification

## 3.1 Absolute Maximum Ratings

Item	Symbol	Min	Max	Unit	Note
Digital Supply Voltage	VCC	-0.3	7.0	V	1
Operating Temperature	Тор	-20	+70	°C	-
Storage Temperature	T <sub>ST</sub>	-30	80	°C	-

**Note 1:** When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. For normal operations, it is desirable to use this module under the conditions according to Section 3.2 "Electrical Characteristics", to avoid malfunctioning.

Note 2: Background colour changes slightly depending on ambient temperature. This phenomenon is reversible.

Note 3: Please refer to item of RELIABILITY.

#### 3.2 Electrical Characteristics

#### 3.2.1 DC Electrical Characteristics

ltem	Symbol	Condition	Min	Тур.	Max	Unit	Note
Digital Supply Voltage	VCC	-	3.0	3.3	3.6	V	-
Normal Mode Current	ICC	-	-	(10)	-	mA	-
Level Imput Valtage	VIH	-	0.7*VCC	-	VCC	V	-
Level Input Voltage	V <sub>IL</sub>	-	0	-	0.3*VDD	V	-
Lavel Outrot Valtage	Vон	-	0.8*VCC	-	VCC	V	-
Level Output Voltage	V <sub>OL</sub>	-	0	-	0.2*VCC	V	-

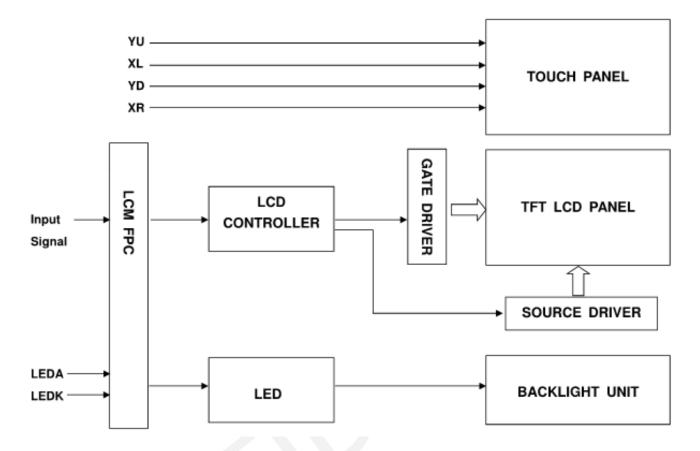


# 3.3 Interface Pin Assignment

No.	Symbol	I/O	Function
1	GND	Р	Ground
2	DCLK	ı	Input clock signal. Latch data at DCLK falling edge. (Default)
3	HSYNC	ı	Horizontal sync input in digital RGB and CCIR601 mode.(Short to GND if not used)
4	VSYNC	ı	Vertical sync input in digital RGB and CCIR601 mode.(Short to GND if not used)
5	GND	Р	Ground
6-11	R0-R5	ı	Red data input
12	GND	Р	Ground
13-18	G0-G5	I	Green data input
19	GND	Р	Ground
20-25	B0-B5	ı	Blue data input
26	GND	Р	Ground
27	DEN	I	Data Enable
28	VCC	Р	Power supply for LCD
29	VCC	Р	Power supply for LCD
30	L/R	1	The shift direction of device internal shift register is controlled by this pin as shown below: $ LR=H: STH \rightarrow SO1 \rightarrow \bullet \bullet \bullet \rightarrow SO960 \rightarrow STHO $ $ LR=L: STH \rightarrow SO960 \rightarrow \bullet \bullet \bullet \rightarrow SO1 \rightarrow STHO $
31	U/D	1	Up/down scan setting. When UD=H, reverse scan. When UD=L, normal scan.
32	VCC	Р	Power supply for LCD
33	LED-	Р	LED Cathode
34-36	NC	-	-
37	LED+	Р	LED Anode
38-40	NC	-	-



## 3.4 Block Diagram

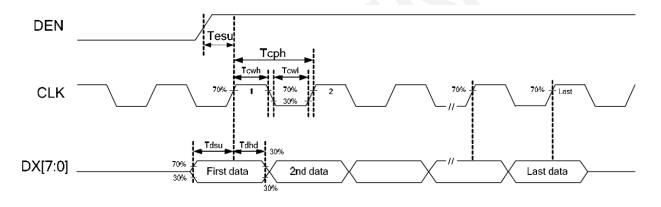


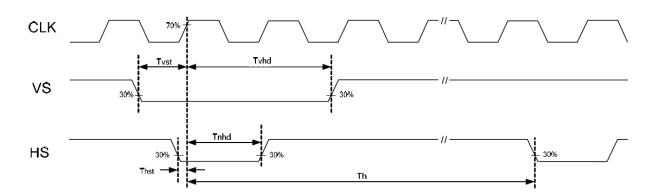


## 3.5 Timing Characteristics

## 3.5.1 Input Clock and Data Timing

Item	Symbol	Condition	Min	Тур.	Max	Unit
HSD Setup Time	Thst	-	10	-	-	ns
HSD Hold Time	Thhd	-	10	-	-	ns
VSD Setup Time	Tcst	-	10	-	-	ns
VSD Hold Time	Tchd	-	10	-	-	ns
Data Setup Time	Tdsu	D0[5:0], D1[5:0], D2[5:0] to DCLK	10	-	-	ns
Data Hold Time	Tdhd	D0[5:0], D1[5:0], D2[5:0] to DCLK	10	-	-	ns
RSTB Low Pulse Width	TRst	-	10	-	-	us
DCLK Cycle Time	Tcph	-	-	39.7	-	ns
DCLK Pulse Duty	Tcwh	-	40	50	60	%
DEN Setup Time	Tesu	-	10	-	-	ns





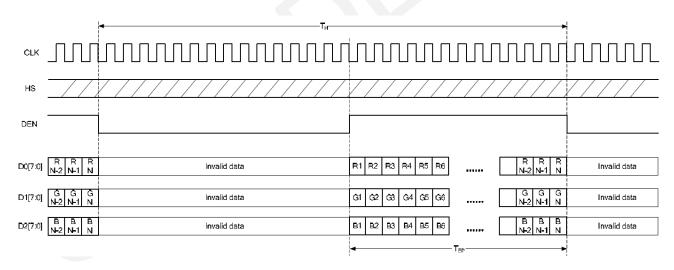


#### 3.5.2 Input Timing

ltem	Symbol	Min	Тур.	Max	Unit	Note
CLK frequency	F <sub>CPH</sub>	-	25.175	-	MHz	-
CLK period	Тсрн	-	39.7	-	ns	-
CLK pulse duty	T <sub>CWH</sub>	40	50	60	%	-
HS period	Тн	-	800	-	Тсрн	-
HS Effective time	T <sub>HA</sub>		640		Т <sub>СРН</sub>	
HS pulse width	Тwн	5	30		Тсрн	-
HS-first horizontal data time	T <sub>HS</sub>	112	144	175	Тсрн	-
DEN pulse width	T <sub>EP</sub>	-	640	-	Тсрн	_
VS pulse width	Twv	1	3	5	Тн	-
VS-DEN time	T <sub>STV</sub>	-	35	-	Тн	-
VS period	Tv	-	525	-	Тн	-
VS Effective time	Tva		480		Тн	-

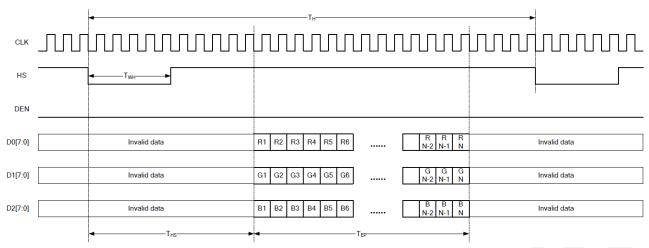
Note: When SYNC mode is used, 1st data start from 144th CLK after HS falling.

#### **RGB DE Mode Horizontal Data Format**

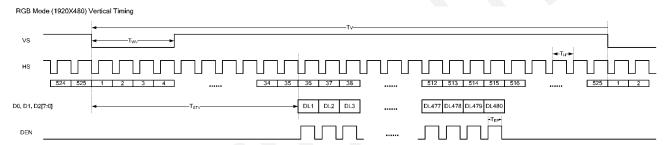




#### **RGB SYNC Mode Horizontal Data Format**



#### **RGB Mode Vertical Data Format**





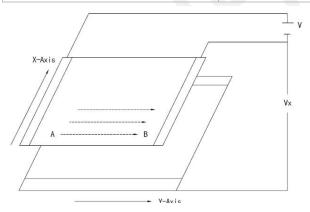
# 4. Electrical Specification Touch

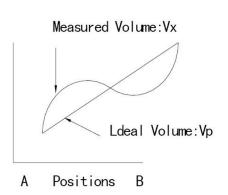
## 4.1 Conditions of Use and Storage

Item	Value (Condition)	Note
Temperature Range Upon Operation	Humidity: 20%~90% non dew,	In a simple substance
Townsysters Dange Linea Storage	Humidity: 20%~90% non dew,	In a simple substance
Temperature Range Upon Storage	condensation -30°C~80°C	In a simple substance

## 4.2 Electrical Property

Item	Value	Note
Maximum Voltage	DC5V	_
Desistan es hatros en Tamainale	X direction [Film side]: 200-600Ω	
Resistance between Terminals	Y direction [Glass side]:300-900Ω	
Insulation Resistance	DC 25V 20MΩor above	Connect X + $\sim$ X- and Y+ $\sim$ Y-, apply 25VDC Between X and Y for perform measurements
Chattering	10 msec or below	-
Rating	Voltage is DC 5V	-







# 4.3 Mechanical Property

Item	Performance		Note
Input Method	Used of an exclu	sive pen or finger	
	Exclusive Pen	60~100g or below	Operation and measurement with a pen must be carried out under the following tip conditions: Stylus pen material: POM (ployacetal).  Tip: Diameter 3.0mm, SR 0.8 mm
Load Upon Operation	Upon Operation Finger	60~100g or below	Operations and measurement methods simulated for a finger must be carried out under the following tip conditions.  Material: Silicon rubber (Hardness: 30°Hs)  Tip: Diameter 12.0 mm, SR 12.5mm
Surface Hardness	Pencil Hardness: 3H or above		It complies with the way of test method  JIS K5400.



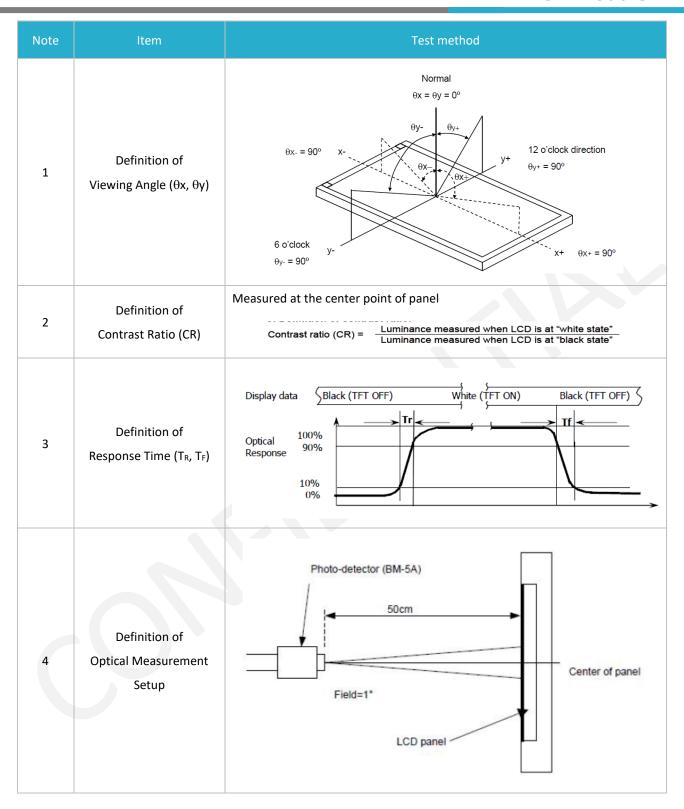
# 5. Optical Specification

## 5.1 Optical Characteristics

Charac	cteristics	Symbol	Conditions	Min	Тур.	Max	Unit	Note
Contra	st Ratio	CR	θ = 0°	500	800	-	-	1, 2
Respo	nse time	TR + TF	Normal viewing angle	-	25	40	msec	1, 3
<u>9</u>	Left	θ <sub>x</sub> -		-	70			1, 4
Viewing Angle	Right	θ <sub>x</sub> +	CD> 10	-	70			
wing	Up	θ <sub>Y</sub> +	CR>10	-	60	-		
\ <del>j</del>	Down	θ <sub>Y</sub> -		-	40	-		
Colour	Red	Rx	θ = 0° Normal	(0.273)	(0.303)	(0.333)		1, 4
Co	Chro	Ry	viewing angle	(0.303)	(0.333)	(0.363)		
Lumi	inance	Lv	I <sub>F</sub> = 60mA		(650)	-	cd/m²	4

**Note:** Measuring Condition = in dark room, at ambient temperature 25±2°C, for 15min, warm-up time.







# 6. LED Backlight Specification

## 6.1 LED Backlight Characteristics

The back-light system is edge-lighting type with 24 chips LED.

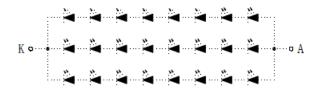
Item	Symbol	Condition	Min	Тур.	Max	Unit	Note
Forward Current	l <sub>F</sub>	-	-	60	90	mA	-
Forward Voltage	VF	-	21.6	24	25.6	V	-
LED Life Time	Hr	-	(50000)	-	-	Hour	1, 2

**Note 1:** LED life time (Hr) can be defined as the time in which it continues to operate under the condition:

Ta=25±3°C, typical IL (I<sub>F</sub>) value indicated in the above table until the brightness becomes less than 50%.

Note 2: The "LED life time" is defined as the module brightness decreases to 50% original brightness at Ta=25°C and IL=60mA. The LED lifetime could be decreased if operating IL is larger than 60mA. The constant current driving method is suggested.

#### 6.2 INTERNAL CIRCUIT DIAGRAM





# 7. Packaging

TBD



## 8. Quality Assurance Specification

#### 8.1 Conformity

The performance, function and reliability of the shipped products conform to the Product Specification.

#### 8.2 Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

Temperature:  $25 \pm 5^{\circ}$ C

Humidity:  $65\% \pm 10\% \text{ RH}$ 

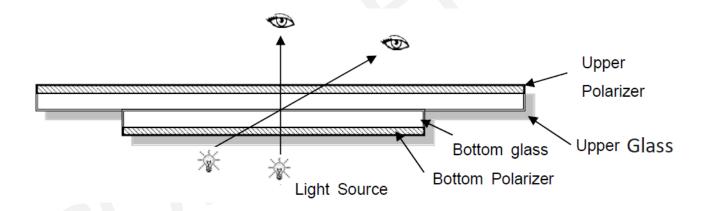
Viewing Angle: Normal Viewing Angle

Illumination: Single fluorescent lamp (300 to 700 Lux)

Viewing distance: 30 - 50cm

Finger glove (or finger cover) must be worn by the inspector.

Inspection table or jig must be anti-electrostatic.



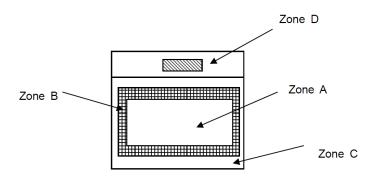
#### 8.3 Delivery Assurance

#### 8.3.1 Delivery Inspection Standards

Class II, Normal Inspection, MIL-STD-105E



#### 8.3.2 Zone Definition



Zone A: Effective Viewing Area (Character or Digit can be seen)

Zone B: Viewing Area except Zone A

Zone C: Outside (Zone A + Zone B) Area which cannot be seen after assembly by customer.

Zone D: IC Bonding Area

**Note:** Generally, visual defects in Zone C can be ignored when it doesn't affect product function or appearance after assembly by customer



## 8.3.3 Criteria & Acceptable Quality Level

Partition	AQL	Definition
Major	0.65	Defects in Pattern Check (Display On)
Minor	1.5	Defects in Cosmetic Check (Display Off)

#### LCD: Liquid Crystal Display, TP: Touch Panel, LCM: Liquid Crystal Module

No.	Items	Criteria	Classification of defects	
1	Functional defects	<ol> <li>No display, open or miss line</li> <li>Display abnormally, short.</li> <li>Backlight no lighting, abnormal lighting.</li> <li>TP no function</li> </ol>	Major	
2	Missing	Missing component ad etc.		
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed, deformation and etc.		
4	Color tone Color unevenness, refer to limited sample			
5	Spot Line defect	Light dot, Dim spot Polarizer Bubble; Polarizer accidented spot	Minor	
6	Soldering Appearance	Good soldering, peeling off is not allowed and etc.		
7	LCD/Polarizer/RTP Black/White spot/line, scratch, crack, etc.			



#### 8.3.4 Criteria & Classification

Units: mm

Class	ltem		Criteria				
		Round type: as per f	following drawing, $\emptyset = (X+Y)/2$	X	<u>†</u> Y		
		1) Light Dot (black/white spot, pinhole, stain.)					
		Size\Zone	Acceptabl	e Quantity			
		Size\zone	А	В	С		
		Ø≤0.15	Ignore				
		0.15<∅≤0.25	3 (distance ≥ 10mm	n)			
		0.25<∅≤0.40	2 (distance ≥ 10mm)		Ignore		
		0.4<∅	0.4<∅ 0				
		2) Dim Spot (Light	2) Dim Spot (Light leakage, dent, dark spot.)				
		6: \7	Acceptable Quantity				
	Size\Zone	A	В	С			
		Ø≤0.15	Ignore		lgnore		
Minor	Spot Defect	0.15<∅≤0.25	3 (distance ≥ 10mm				
		0.25<∅≤0.40	2 (distance ≥ 10mm				
		0.4<∅					
		3) Polarizer Accide	ented Spot				
		61. 17	Acceptabl	e Quantity			
		Size\Zone -	А	В	С		
		Ø≤0.2	Ignore				
		0.2<∅≤0.5	2 (distance ≥ 10mn	n)	Ignore		
		0.5<∅	0				
		4) Pixel Bad Points	3				
		Item	Zone A	Acceptal	ble Quantity		
			Random		N≤2		
		Bright Dot	2 Dots Adjacent		N≤0		
			3 Dots Adjacent		N≤0		
		Dark Dot	Random		N≤2		
		Daik Dut	2 Dots Adjacent		N≤0		



Class	ltem		Criteria			
			3 Dots Adjacent	1	N≤0	
			1. Minimum Distance			
			Between Bright dots.			
		Distance	2. Minimum Distance	_		
		Distance	Between dark dots	5	mm	
			3. Minimum Distance			
			Between dark and bright dot.			
		Total	bright and dark dot	1	N≤4	
		Note:				
		A) Bright dot : D	ots appear bright and unchange	ed in size in wh	ich LCD panel is	
		displaying under b	displaying under black pattern.			
		B) Dark dot: Dots a	appear dark and unchanged in siz	e in which LCD p	anel is displaying	
		under pure red, gr	een, blue picture.			
		C) 2 dot adjacent = 1 pair = 2 dots				
		Picture:				
		2 dot ad	jacent	2 dot adjad	cent	
		2 dot adjace	ent (vertical)	2 dot adjac	ent (slant)	
		5) Polarizer Bubb	ole			
		Size\Zone	Acceptab	le Quantity		
			A	В	С	
		Ø≤ <b>0</b> .2	Ignore			
		0.2<∅≤0.4	3 (distance ≥ 10m	m)	Ignore	
		0.4<∅	0			
Minor	Polarizer backlight black/white line, scratch, stain)	Line type: as per following drawing				



Class	Item		Criteria			
		AA77 IN		Acce	ptable qua	ntity
		Width	Length	Α	В	С
		W≤0.05	Ignore	Igno	ore	
		0.05 <w≤0.06< td=""><td>L ≤ 4.0</td><td>N≤</td><td>3</td><td>Ignore</td></w≤0.06<>	L ≤ 4.0	N≤	3	Ignore
		0.06 <w≤0.08< td=""><td>L ≤ 3.0</td><td>N≤</td><td>2</td><td></td></w≤0.08<>	L ≤ 3.0	N≤	2	
		0.08 <w< td=""><td>Define as</td><td>spot defect</td><td></td><td></td></w<>	Define as	spot defect		
		Symbols:				
		X: Length, Y: Width	n, Z: Height, L: Length of ITO, T: Ho	eight of LCD		
		1) The edge of LO	CD broken: X≦3.0mm; Y <inner bo<="" td=""><td>rder line of t</td><td>he seal; Z≦</td><td>Т</td></inner>	rder line of t	he seal; Z≦	Т
Minor	LCD Crack/Broken  2) LCD corner broken: X≦3.0mm; Y≦L; Z≦T					
Major	LCD Crack	The LCD with exter	nsive crack is not acceptable.			
Major	Electronic Components SMT	Not allow missing parts, solderless connection, cold solder joint, mismatch.  The positive and negative polarity opposite.				

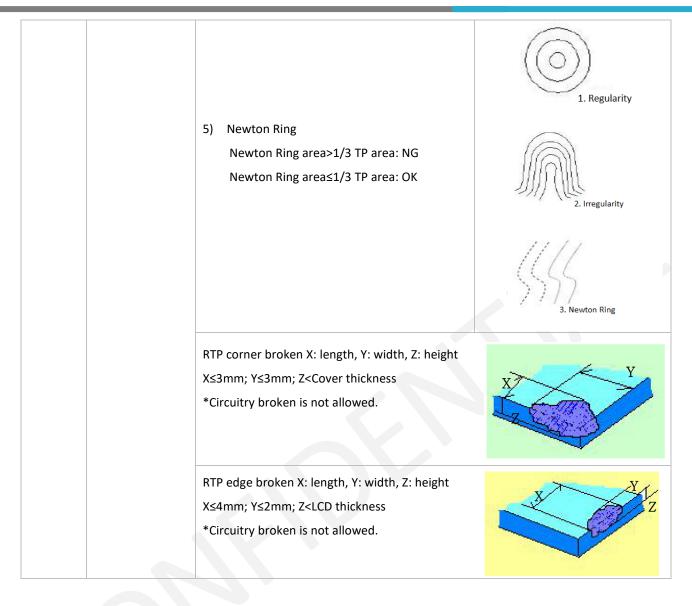


Class	Item	Criteria
Minor	Display color& Brightness	<ol> <li>Color: Measuring the color coordinates, The measurement standard according to the datasheet or samples.</li> <li>Brightness: Measuring the brightness of White screen, The measurement standard according to the datasheet or Samples.</li> </ol>
Minor	LCD Mura/Waving/ Hot Spot	Not visible through 5% ND filter in 50% gray or judge by limit sample if necessary.

Class	Item	Criteria				
		1) RTP Film Bubble/Accidented Spot				
		Size\Zone -		Accept	cable Qty	
		Size\zone	А		В	С
	Ø≤ <b>0</b> .1		Ignore			
		0.1<∅≤0.25	3 ( dis	stance≧10mm)		lanoro
		0.25<∅≤0.35	2 ( dis	stance≧10mm)		Ignore
		Ø>0.35		0		
		2) RTP Film Scratc	:h			
		Width		Acceptable Qty		Qty
	wiath	Length	А	В	С	
Minor	RTP Related	Ф≤0.05	Ignore	Ignore		
		0.05 <w≤0.06< td=""><td>L≤3.0</td><td colspan="2">N≤2</td><td>Ignore</td></w≤0.06<>	L≤3.0	N≤2		Ignore
		0.06 <w≤0.08< td=""><td>L≤2.0</td><td colspan="2">N≤1</td><td></td></w≤0.08<>	L≤2.0	N≤1		
		0.08 <w< td=""><td></td><td>Define as</td><td>spot defect</td><td></td></w<>		Define as	spot defect	
		3) Assembly Defle	ection: beyond th	ne edge of backl	ight ≤0.2mm	
		4) Bulge (Undulation Included)				
		The ITO film plu	umped below 0.	40mm, it's ok.		
					<u> </u>	
					<0.4	mm









#### Criteria (functional items)

No.	ltem	Criteria
1	No display	
2	Missing segment	
3	Short	Not allowed
4	Backlight no lighting	
5	RTP no function	



#### 8.4 Dealing with Customer Complaints

#### 8.4.1 Non-conforming Analysis

Purchaser should supply Densitron with detailed data of non-conforming sample.

After accepting it, Densitron should complete the analysis in two weeks from receiving the sample.

If the analysis cannot be completed on time, Densitron must inform the purchaser.

#### 8.4.2 Handling of Non-conforming Displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of non-conforming displays when the

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.



# 9. Reliability Specification

#### 9.1 Reliability Tests

Test Item	Test Condition	Evaluation and assessment
High Temperature Operation	70°C, 96 hrs	
Low Temperature Operation	-20°C, 96 hrs	
High Temperature Storage	80°C, 96 hrs	Inspection after 2~4hours storage at room temperature, the sample shall be free from defects:  1) Air bubble in the LCD; 2) Non-display; 3) Missing segments/line; 4) Glass crack; 5) Current IDD is twice higher than initial value.
Low Temperature Storage	-30°C, 96 hrs	
High Temperature & High Humidity Operation	+60°C, 90% RH, 96 hours	
Thermal Shock (Non-operation)	-30°C,30 min ↔ 80°C,30 min, Change time: 5min 20CYC.	
ESD test	C=150pF, R=330,5points/panel  Air:±8KV, 5times; Contact:±6KV, 5 times;  (Environment: 15°C~35°C, 30%~60%).	
Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm  Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total) (Package condition).	
Box Drop Test	1 Corner 3 Edges 6 faces, 80 cm (MEDIUM BOX)	

**Note 1:** The test samples should be applied to only one test item.

Note 2: Sample size for each test item is 5~10pcs.

**Note 3:** For Damp Proof Test, Pure water(Resistance > 10M  $\Omega$ ) should be used.

**Note 4:** In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.

**Note 5:** Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

Note 6: The color fading mura of polarizing filter should not care.

#### 9.1.1 Inspection Check Standard

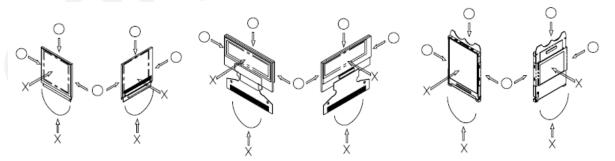
After the completion of the described reliability test, the samples are to be left at room temperature for 4 hrs prior to conducting the inspection check at  $25\pm5$  °C,  $65\pm10\%$  RH.



# 10. Handling Precautions

#### 10.1 Handling Precautions

- 1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If the liquid crystal touches your skin or clothes, wash it off immediately using soap and plenty of water
- 4) If pressure is applied to the display surface or its neighbourhood of the display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 5) The polarizer covering the surface of the display module is soft and easily scratched. Please be careful when handling the display module.
- 6) When the surface of the polarizer of the display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
  - a. Scotch Mending Tape No. 810 or an equivalent
  - b. Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.
  - c. Also, pay attention that the following liquid and solvent may spoil the polarizer:
    - Water
    - Ketone
    - Aromatic Solvents
- 7) Hold the display module very carefully when placing it into the system housing. Do not apply excessive stress or pressure to display module. And, do not over bend the film with electrode pattern layouts. These stresses will



influence the display performance. Also, secure sufficient rigidity for the outer cases.

- 8) Do not apply stress to the LSI chips and the surrounding molded sections.
- 9) Do not disassemble nor modify the display module.
- 10) Do not apply input signals while the logic power is off.
- 11) Pay sufficient attention to the working environments when handing display modules to prevent occurrence of element breakage accidents by static electricity.



- a. Be sure to make human body grounding when handling display modules.
- b. Be sure to ground tools to use or assembly such as soldering irons.
- c. To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- d. Protective film is being applied to the surface of the display panel of the display module. Be careful since static electricity may be generated when exfoliating the protective film.
- 12) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. If the display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
- 13) If electric current is applied when the display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

#### 10.2 Storage Precautions

- 1) When storing display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps, etc. and, also, avoiding high temperature and high humidity environments or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Densitron) At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- 2) If electric current is applied when water drops are adhering to the surface of the display module, when the display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

#### 10.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighbouring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the display module, fasten the external plastic housing section.
- 7) If power supply to the display module is forcibly shut down by such errors as taking out the main battery while the display panel is in operation, we cannot guarantee the quality of this display module.



#### **10.4 Operation Precautions**

- 1) It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life.
- 2) Direct current causes an electrochemical reaction with remarkable deterioration of the display quality. Give careful consideration to prevent direct current during ON/OFF timing and during operation.
- 3) Response time is extremely delayed at temperatures lower than the operating temperature range while, at high temperatures, displays become dark. However, this phenomenon is reversible and does not mean a malfunction or a display that has been permanently damaged.
- 4) To protect display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the display modules.
  - a. Pins and electrodes
  - b. Pattern layouts such as the FPC
- 5) When the driver is being exposed (COG), semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if the driver is exposed to light, malfunctioning may occur.
  - a. Design the product and installation method so that the driver may be shielded from light in actual usage.
  - b. Design the product and installation method so that the driver may be shielded from light during the inspection processes.
- 6) Although the display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- 7) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

#### 10.5 Other Precautions

1) Request the qualified companies to handle industrial wastes when disposing of the display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.